Am9216 2048 x 8 Read Only Memory

DISTINCTIVE CHARACTERISTICS

- 2048 x 8 organization
- High speed 300 ns access time
- Fully capacitive inputs simplified driving
- 2 fully programmable chip selects increased flexibility
- · Logic voltage levels compatible with TTL
- Three-state output buffers simplified expansion
- Standard supply voltages +12V, +5.0V
- No V_{BB} supply required
- N-channel silicon gate MOS technology
- 100% MIL-STD-883 reliability assurance testing

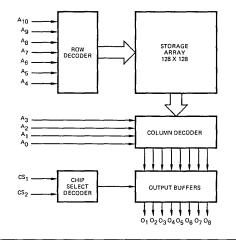
FUNCTIONAL DESCRIPTION

The Am9216 devices are high performance, 16384-bit, static, mask programmed, read only memories. Each memory is implemented as 2048 words by 8 bits per word. This organization simplifies the design of small memory systems and permits incremental memory sizes as small as 2048 words. The fast access times provided allow the ROM to service high performance microcomputer applications without stalling the processor.

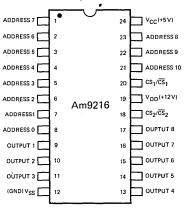
Two Chip Select input signals are logically ANDed together to provide control of the output buffers. Each Chip Select polarity may be specified by the customer thus allowing the addressing of 4 memory chips without external gating. The outputs of unselected chips are turned off and assume a high impedance state. This permits wire-ORing with additional Am9216 devices and other three-state components.

These memories are fully static and require no clock signals of any kind. A selected chip will output data from a location specified by whatever address is present on the address input lines. The Am9216 is pin compatible with the Am9208 which is an 8k-bit mask programmed ROM. Input and output voltage levels are compatible with TTL specifications.

BLOCK DIAGRAM



CONNECTION DIAGRAM Top View



Note: Pin 1 is marked for orientation.

ORDERING INFORMATION

	Ambient Temperature	Access Time								
Package Type	Specifications	400ns	300ns							
Hermetic DIP	$0^{\circ}C \leq T_{A} \leq 70^{\circ}C$	AM9216BDC	AM9216CDC							
Hermed DIF	$-55^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +125^{\circ}\text{C}$	AM9216BDM								

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MAXIMUM RATINGS (Above which the useful life may be impaired)

Storage Temperature	−65°C to +150°C
Ambient Temperature Under Bias	–55°C to +125°C
V _{DD} with Respect to V _{SS}	15 V
V _{CC} with Respect to V _{SS}	+7.0 V
DC Voltage Applied to Outputs	-0.5 V to +7.0 V
DC Input Voltage	-0.5V to +7.0V
Power Dissipation	1.0W

The products described by this specification include internal circuitry designed to protect input devices from damaging accumulations of static charge. It is suggested nevertheless, that conventional precautions be observed during storage, handling and use in order to avoid exposure to excessive voltages.

OPERATING RANGE

Part Number	Ambient Temperature	V _{DD}	V _{CC}	V_{SS}
Am9216DC	0°C ≤ T _A ≤ +70°C	+12V ± 5%	+5.0 V ± 5%	0 V
Am9216DM	-55°C ≤ T _A ≤ +125°C	+12V ± 10%	+5.0V ± 10%	0 V

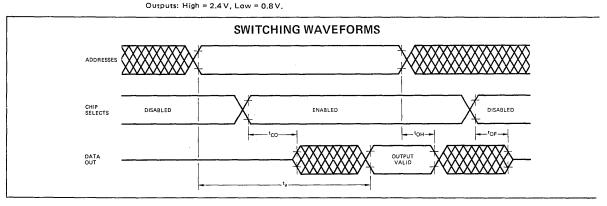
ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

				Am9	216DC	Am9			
arameters	Description	Test Cond	litions	Min.	Max.	Min.	Max.	Units	
V	Output HIGH Voltage	I _{OH} = -1.0mA		3.7		3.7			
VOH	Output HIGH Voltage	I _{OH} = -4.0 mA		2.4		2.4		Volts	
VOL	Output LOW Voltage	I _{OL} = 3.2mA			0.4		0.4	Volts	
V _{IH}	Input HIGH Voltage			2.4	V _{CC} + 1.0	2.6	V _{CC} + 1.0	Volts	
VIL	Input LOW Voltage			-0.5	0.8	-0.5	0.8	Volts	
ILO	Output Leakage Current	Chip disabled			10		10	μА	
ILI	Input Leakage Current				10		10	μА	
		Selected	Am9216B		42		47		
IDD	V _{DD} Supply Current	Selected	Am9216C		49		47	^	
.00	V DD dappily current	Deselected	Am9216B		52		57	mA	
		Deselected	Am9216C		60		37		
¹cc	V _{CC} Supply Current	Am9216B Am9216C			13		15	0	
	A CC arbbit carrent				15		15	mA	

SWITCHING CHARACTERISTICS OVER OPERATING RANGE

Am9216BD0	C, Am9216BDM, Am9216CDC	Am921	6DC/DM	Am92	16CDC		
Parameters	Description	Test Conditions	Min.	Max.	Min.	Max.	Units
ta	Address to Output Access Time			400		300	ns
tCO	Chip Select to Output ON Delay	$t_r = t_f = 20 \text{ns}$		160		140	ns
tОН	Previous Read Data Valid with Respect to Address Change	Output load: one standard TTL gate plus 100pF (Note 1)	20		20		ns
t _{DF}	Chip Select to Output OFF Delay	,		120]	100	ns
cı	Input Capacitance	T _A = 25°C, f = 1.0MHz		6.0		6.0	pF
c o	Output Capacitance	All pins at 0 V		6.0		6.0	pF

Notes: 1. Timing reference levels — Inputs: High = $2.0\,\mathrm{V}$, Low = $1.0\,\mathrm{V}$.



TYPICAL CHARACTERISTICS

IDD, ICC Versus
Temperature (Normalized)

1.4

1.3

V_{CC} = 5.5 V

V_{DD} = 13.2 V

1.0

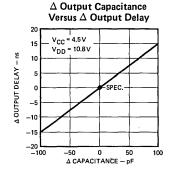
0.6

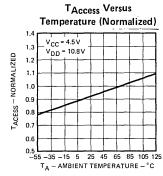
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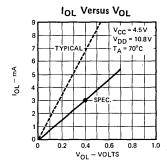
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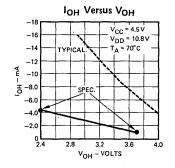
0.5

T_A - AMBIENT TEMPERATURE - °C









PROGRAMMING INSTRUCTIONS CUSTOM PATTERN ORDERING INFORMATION

The Am9216 is programmed from punched cards, card coding forms or from paper tape in card image form in the format as shown below.

Logic "1" = a more positive voltage (normally +5.0 V) Logic "0" = a more negative voltage (normally 0V)

FIRST CARD

Column Number
10 thru 29
32 thru 37
Customer Name
Total number of "1's" contained in the data.
This is optional and should be left blank if not used.

50 thru 62
65 thru 72
9216B or 9216C
Data

SECOND CARD

Column Number
31 CS2 input required to select chip (0 or 1)
33 CS1 input required to select chip (0 or 1)

Two options are provided for entering the data pattern with the remaining cards.

OPTION 1 is the Binary Option where the address and data are presented in binary form on the basis of one word per card. With this option 2048 data cards are required.

Column Number

10, 12, 14, 16, 18
20, 22, 24, 26, 28, 30
40, 42, 44, 46, 48.

Address input pattern with the most significant bit (A₁₀) in column 10 and the least significant bit (A₀) in column 30.

Output pattern with the most significant bit (O₈) in column 40 and the least significant bit (O₁) in

50, 52, 54

Output pattern with the most significant bit (O_8) in column 40 and the least significant bit (O_1) in column 54.

73 thru 80 Coding these columns is not essential and may be used for card identification purposes.

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OPTION 2 is the Hexadecimal Option and is a much more compact way of presenting the data. This format requires only 128 data cards. Each data card contains the 8-bit output information for 16 storage locations in the memory. The address indicated in columns 21, 22 and 23 is the address of the data presented in columns 30 and 31. Addresses for successive data are assumed to be in incremental ascending order from the initial address. Since the address in columns 21, 22 and 23 always points only to the first data on the card, column 23 is always zero. Columns 21 and 22 take all hex values from 00 through 7F: 128 cards in all. Data is entered in hex values and may be any combination of 8 bits, that is, hex values from 00 through FF.

		OUTPUT VALUES FOR ADDR +																															
A D R		0		1		2		3		4		5		6		7		8		9			Α		В		С		D		E		F
21 22	23	30 31	32	33 34	35	36 37	38	39 4	0 41	42 43	44	45 46	47	48 49	50	51 52	53	54	55 5	57	58 5	9 60	61	62	63 64	65	66 6	7 6	69 70	71	72 73	74	75 76
0 0	0		Н		\perp		 	\perp	4	igspace	L	Ш.	-	1	_		-	μ	+	\sqcup	-	\downarrow		_		-	1	\downarrow	1-1-			Н	ᆚᅱ
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